

DATA IMAGE CORPORATION

TFT Module Specification PRELIMINARY

ITEM NO.: SCF1001102GGU15

Table of Contents

1.	COVER & CONTENTS ······	1
2.	RECORD OF REVISION	2
3.	GENERAL DESCRIPTIONS ······	3
4.	LCD ABSOLUTE MAXIMUM RATING	4
5.	LCD PIXEL FORMAT IMAGE ·····	5
6.	OPTICAL CHARACTERISTICS ······	6
7.	BACKLIGHT CHARACTERISTICS ······	9
8.	LCD ELECTRICIAL CHARACTERISTICS ······	9
9.	LCD INTERFACE TIMINGS	14
10.	LCD POWER CONSUMPTION ······	15
11.	LCD POWER ON/OFF SEQUENCE	16
12.	CTP GENERAL SEPCIFICATIONS ······	17
13.	APPEARANCE SEPCIFICATION	18
14.	CTP LCM PRODUCT LABEL DEDFINE ······	22
15.	PRECAUTIONS IN USE LCM ·····	24
16.	OUTLINE DRAWING ·····	25
17.	PACKAGE INFORMATION ·····	26

Customer Companies	R&D Dept.	Q.C. Dept.	Eng. Dept.	Prod. Dept.
	ALEX	JOE	GARY	KEN
Approved by	Version:	Issued Date:	Sheet Code:	Total Pages:
	1	12/MAY/14'		26



2. RECORD OF REVISION

Rev	Date	Item	Page	Comment
1	12/MAY/14'			Initial PRELIMINARY



3. GENERAL SPECIFICATIONS

Composition: 10.1 inch WSVGA resolution display with a projected Capacitive Touch Panel (CTP). Interface : LVDS Interface for panel and USB for the CTP.

No.	Item Specification						
1	LCD size	10.1 (Diagonal)	inch				
2	Outline Dimension	240.4(W) x 143.1(H) x 7.45(D)	mm				
3	LCD Active Area	222.72(W) x 125.28(H)	mm				
4	Sensor Active Area	223.72(W) x 126.28(H)	mm				
5	Number of Pixel	1024(H) × (RGB) × 600 (V)	pixels				
6	Dot pitch	0.22(H) × 0.21(V)	mm				
7	Display mode	Normally white					
8	Surface treatment	Glare					
9	Weight	TBD	g				
11	View direction	6 o'clock					
12	LCM part number	FG100131DNSWAG01					
13	Operating temperature	0~50	°C				
14	Storage temperature	-20 ~ 60					

3.1 Functional Block Diagram



Figure 1 shows the functional block diagram of the LCD module.



4. LCD ABSOLUTE MAXIMUM RATINGS

ltem	Symbol	Min	Мах	Unit	Conditions
Supply Voltage	VDD	-0.3	4.0	V	Typ.=3.3V
Input Signal		-0.3	2.7	V	LVDS signals
Operating Temperature	TOP	0	50	°C	(Note 3)
Operating Humidity	HOP	10	80	% RH	(Note 3)
Storage Temperature	TST	-20	60	°C	(Note 3)
Storage Humidity	HST	10	90	% RH	(Note 3)
Vibration			1.5G	G	20 min for XIX Z ovia
VIDIALION			10~500Hz	Hz	
Shook			220	G	
SHUCK			2	mS	nali sigli wave
LED Current	I-LED		(20)	mA	per LED

Table 1

Note:

- (1) Maximum Wet-Bulb should be 39°C. No condensation.
- (2) When you apply the LCD module for OA system. Please make sure to keep the temperature of LCD module is less than 60°C.
- (3) Storage /Operating temperature





	1			2			3							1	02	3	1	02	4	
1	R	G		R	G		R	G		 	:	 	:	R	G		R	G	В	
2	R	G		R	G		R	G		 		 		R	G		R	G	В	
3	R	G		R	G		R	G		 •••		 		R	G		R	G	В	
4	R	G		R	G		R	G		 		 		R	G		R	G	В	
6	R	G		R	G		R	G		 		 		R	G		R	G	В	
	:	:	:	:	:	:	:	:	:					:	:	:	:	:	:	
	:	:	:	:	:	:	:	:	:					:	:	:	:	:	:	
	:	:	:	:	:	:	:	:	:					:	:	:	:	:	:	
	:	:	:	:	:	:	:	:	:					:	:	:	:	:	:	
	:	:	:	:	:	:	:	:	:					:	:	:	:	:	:	
699	R	G		R	G		R	G		 		 	• •	R	G		R	G	В	
600	R	G		R	G		R	G		 	•••	 •••		R	G		R	G	В	

Figure 2 shows the relationship of the input signals and LCD pixel format image.



The optical characteristics are measured under stable conditions as following notes

Itom	Con	ditions		Specification					
item	CON		Min	Тур.	Max	Note			
	Horizontal	Left	35	45	-				
Viewing Angle [degrees]		Right	35	35 45					
K=Contrast Ratio>10	Vertical	Up	5	15	-	А, В			
		Down	25	25 35					
Contrast ratio	Center		350	450	-	A, C			
Response Time [ms]	Rising + Fa	lling	-	16	-	A, D			
	Red	Х		0.579		А,			
	Red	у	Tup 0.02	0.346		А,			
	Green	х		0.336	$T_{VD} \pm 0.03$	А,			
Color Chromaticity	Green	у	тур0.03	0.560	тур. то.об	А,			
(CIE1931)	Blue	х		0.156		А,			
	Blue	у		0.123		А,			
	White	Х	0.263	0.313	0.365	А,			
	White	у	0.279	0.329	0.379	А,			
White Luminance [cd/m ²]	I-LED=20m	A	120	160	-	5 point A, E			
Luminance Uniformity [9/]	I-LED=20mA, 13points		62.5	-	-				
	I-LED=20m	A , 5points	80.0	-	-	А, Г			

Table 2 Optical Characteristics

Note: A. Measurement Setup:

The LCD module should be stabilized at given temperature for 15 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.



Figure 3 Measurement Setup



Figure 4 Definition of Viewing Angle

C. Definition of Contrast Ratio (CR)

The contrast ratio can be calculated by the following expression

Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63, L0: Luminance of gray level 0

D. Definition of Response Time (TR, TF)







Figure 6 Measurement Locations of 13 Points



 E. Definition of Luminance White Measure the luminance of gray level 63 at center point and 5 points. Center of Luminance = Y1

Average Luminance of 5 points = $\frac{Y1+Y2+Y3+Y4+Y5}{5}$

F. Definition of Luminance Uniformity (Variation) Measure the luminance of gray level 63 at 13 points.

Uniformity of 13 points =
$$\frac{\text{Min Luminance of Y1~Y13}}{\text{Max Luminance of Y1~Y13}} \times 100\%$$

Uniformity of 5 points = $\frac{\text{Min Luminance of Y1~Y5}}{\text{Max Luminance of Y1~Y5}} \times 100\%$



7.1 Parameter Guideline of LED Backlight

Symbol	Parameter	Min.	Тур.	Max.	Units	Condition		
V_LED	LED input	5	12	21	[V]	Ta=25[deg C]		
LT	LED Life Time	10,000	-	-	Hours	Ta=25[deg C] Note C		
	PWM Signal	High	2.0	3.3	3.6	V	_	
	Voltage	Low	0	-	0.5	V	-	
FPWM	Output PWM freque	ncy	-	200	1K	Hz	-	
	LED enable	High	2.0	3.3	3.6			
VLED_EN	Voltage	Low	0	-	0.5	V	-	
PWM	PWM Duty ratio		5		100	%	-	

Table 3 Parameter Guideline for LED Backlight Note A: $I_{\text{LED}}\text{=}20$ mA (Per LED)

Note B: Calculator value for LED chip specification.

Note C: The LED life time define as the estimated time to 50% degradation of initial luminous.

8. LCD ELECTRICAL CHARACTERISTICS

8.1 Interface Connector

Manufacturer	UJU (or equivalent)
Type / Part Number	IS050-L40B-C10

Table 4 Connector Name / Designation



Table 5 Signal Pin Assi	gnment
-------------------------	--------

Pin #	Signal Name	Description	Remarks
1	NC	Not connected	
2	VDD	Power supply 3.3V(Typ.)	
3	VDD	Power supply 3.3V(Typ.)	
4	VEDID	EDID +3.3V Power	
5	BIST	Bist Mode	Reserve for Aging
6	CLK_EDID	EDID Clock Input	
7	DAT_EDID	EDID Data Input	
8	Rin0-	-LVDS differential data input(R0-R5,G0)	
9	Rin0+	+LVDS differential data input(R0-R5,G0)	
10	GND	Ground	
11	Rin1-	-LVDS differential data input(G1-G5,B0-B1)	
12	Rin1+	+LVDS differential data input(G1-G5,B0-B1)	
13	GND	Ground	
14	Rin2-	-LVDS differential data input(B2-B5,HS,VS,DE)	
15	Rin2+	+LVDS differential data input(B2-B5,HS,VS,DE)	
16	GND	Ground	
17	CLKN-	-LVDS differential clock input	
18	CLKN+	+ LVDS differential clock input	
19	NC	Not connected(Reserve)	
20	NC	Not connected(Reserve)	
21	NC	Not connected(Reserve)	
22	GND	Ground-Shield	
23	NC	Not connected(Reserve)	
24	NC	Not connected(Reserve)	
25	GND	Ground-Shield	
26	NC	Not connected(Reserve)	
27	NC	Not connected(Reserve)	
28	GND	Ground-Shield	
29	NC	Not connected(Reserve)	
30	NC	Not connected(Reserve)	
31	VLED_GND	LED Ground	
32	VLED_GND	LED Ground	
33	VLED_GND	LED Ground	
34	NC	Not connected(Reserve)	
35	VPWM_EN	System PWM Logic Input Level	
36	VLED_EN	LED enable Input Level(+3.3V)	
37	NC	Not connected(Reserve)	
38	VLED	LED Power Supply 521V	
39	VLED	LED Power Supply 521V	
40	VLED	LED Power Supply 521V	

All input signals shall be low or Hi-Z state when VDD is off



8.2 LVDS Receiver

8.2.1 Signal Electrical Characteristics for LVDS Receiver

Parameter	Symbol	Min	Тур.	Мах	Unit	Conditions
Differential Input High Threshold	Vth	-	-	+100	mV	Vcm=+1.2V
Differential Input Low Threshold	VtI	-100	-	-	mV	Vcm=+1.2V
Magnitude Differential Input Voltage	Vid	100	-	600	mV	
Common Mode Voltage	Vcm	0.9	1.2	1.5	V	
Common Mode Voltage Offset	ΔVcm	-	-	50	mV	Vcm=+1.2V

The built-in LVDS receiver is compatible with (ANSI/TIA/TIA-644) standard.

Table 6 LVDS Receiver Electrical Characteristics

Note:

A. Input signals shall be low or Hi-Z state when VDD is off.

B. All electrical characteristics for LVDS signal are defined and shall be measured at the interface connector of LCD.

Parameter	Symbol	Min	Тур.	Max	Unit	Conditions	Note
Clock Frequency	Fc	44.4	50.4	65.2	MHz		

Table 7 Timing Requirements

Note: All values are at VDD=3.3V, Ta=25 °C



Figure 7 Voltage Definitions



Figure 8 Measurement System







Note: Tsu and Thd is internal data sampling window of receiver. Trskm is the system skew margin; i.e., the sum of cable skew, source clock jitter, and other inter-symbol interference, shall be less than Trskm.

8.2.2 LVDS Receiver Internal Circuit

Figure 11 LVDS Receiver Internal Circuit shows the internal block diagram of the LVDS receiver. This LCD module equips termination resistors for LVDS link.



Figure 11 LVDS Receiver Internal Circuit



9.1 Timing Characteristics

Parameter	Symbol	Unit	min	Тур.	Max
LVDS Clock	Edok		11 1	50.4	65.2
Frequency(single)	FUCK		44.4	50.4	05.2
H Total Time	Htotal	clocks	1320	1344	1362
H Active Time	Hac	clocks	1024	1024	1024
V Total Time	Vtotal	lines	612	625	638
V Active Time	Vac	lines	600	600	600
Frame Rate	Vsync	Hz	55	60	65



Figure 12 Timing Characteristics





Input power specifications are as follows.

Symbol	Parameter	Min	Тур.	Max	Units	Condition
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[V]	
IDD	VDD Current		160		[A]	All black pattern, 60Hz
PDD	VDD Power			0.53	[W]	Max pattern, 60Hz
Irush	Rush Current			2	[A]	
	Allowable Logic/LCD Drive			200	[m\/n n]	
VDDip	Ripple Voltage			300	[IIIvb-b]	

Table 9 Power Consumption



11. LCD POWER ON/OFF SEQUENCE

VDD power, interface signals, and lamp on/off sequence are shown in

Figure 13.Signals shall be Hi-Z state or low level when VDD is off.



Figure	13	Power	Seq	uence
--------	----	-------	-----	-------

Parameter	Symbol	min	Тур.	max	Unit
VDD Rise Time	T1	0.5		10	ms
VDD Good to Signal Valid	T2	30		90	ms
Signal Valid to Backlight On	Т3	200			ms
Backlight Power on Time	T4	0.5			ms
Backlight VDD Good to System	TE	10			m 0
PWM on	15	10			ms
System PWM on to Backlight	те	10			ma
Enable on	10	10			1115
Backlight Enable off to System	т7	0			ma
PWM off	17	0			1115
System PWM off to B/L Power	то	10			ma
Disable	10	10			1115
Backlight Power off Time	Т9		10	30	
Backlight Off to Signal Disable	T10	200			ms
Signal Disable to Power Down	T11	0		50	ms
VDD Fall Time	T12		10	30	ms
Power Off	T13	500			ms

Table 10 Power Sequencing Requirements



12. CTP GENERAL SPECIFICATIONS

12.1 CTP main feature

ltem	Specification	Unit
Туре	Transparent type projected capacitive touch panel	
Input mode	Human's finger	
Multi touch	5	Point
(X,Y) Position		

12.2 ABSOLUTE MAXIMUM RATINGS

Symbol	Description	Min	Тур.	Max	Unit	Notes
VCC1	Supply voltage	-0.3	-	6.5	V	
Vio	DC input voltage	-0.3	-	VCC1+0.3	V	

12.3 CTP electrical characteristic

Symbol	Description	Min	Тур.	Max	Unit	Notes
VCC1	Supply voltage		5.0		V	
GND	Supply voltage	-	0	-	V	
I	Supply current		70		mA	At VCC1=5.0

12.4 CTP pin functions

Pin	Symbol	Туре	Description	
1	VCC1	Power	Power; VCC1 =5.0V(typ.)	
2	D-	Signal	USB Signal	
3	D+	Signal	USB Signal	
4	GND	Power	Ground	

Note: Interface protocol please refer to Universal Serial Bus Specification Revision 1.1



13. APPEARANCE SPECIFICATION

13.1 Inspection condition

- 13.1.1 Inspection conditions
 - 13.1.1.1 Inspection Distance : 30 ± 5 cm
 - 13.1.1.2 View Angle :
 - (1) Inspection that light pervious to the product: $90\pm15^{\circ}$
 - (2) Inspection that light reflects on the product: $90\pm15^{\circ}$



13.1.2 Environment conditions :

Ambient Temperature :	25±5 ℃
Ambient Humidity :	30~75%RH
Ambient Illumination	600~800 lux



13.2 Inspection Parameters

Appearance inspection standard (D: diameter, L: length; W: width, Z: height, T: glass thickness)

Inspection item	Inspectior	Description			
No image	Proh				
Image abnormal	Proh				
Bright line	Proh	ibited			
Thin line	It is acceptable that the defec filt	t can not be see er.	n with 5% ND		
Mura	It is acceptable that the defec	t can not be see er.	n with 5% ND		
Dot	Item	Acceptable Visible area	Total		
	Bright dot	3		One Dot	
	Dark dot	5	6		
	Bright adjacent dots	1	1	Two adjacent dot	
	Dark adjacent dots	2	2		
	Adjacent dots with a bright dot and a dark dot	2	2		
Foreign material	SPEC (unit: mm	1)	Acceptable		
in dot shape	D≦0.5		Ignored	0	
	0.5 <d≦0.8, distanc<="" td=""><td>ce>5</td><td>n≦5</td><td colspan="2"></td></d≦0.8,>	ce>5	n≦5		
	D>0.8		0	D= (L + W) / 2	
Foreign material	SPEC		Acceptable	1 . 1	
in line shape	W \leq 0.05 and L \leq	10	Ignored		
	0.05 <w≦0.1, dis<="" l≦10,="" td=""><td>stance >5</td><td>n≦5</td><td></td></w≦0.1,>	stance >5	n≦5		
	W>0.1 or L>10	0	0	L : Long W : Width	
Contamination	It is acceptable if th	e dirt can be wip	ed.		



	GE Confident		
Scratch	SPEC	Acceptable	
	W \leq 0.05 and L \leq 10	Ignored	~~ ~~
	0.05 <w≦0.08, distance="" l≦10,="">5</w≦0.08,>	n≦5	\sim
	0.08 <w<math>\leq0.1, L\leq10, distance >5</w<math>	n≦3	L
	W>0.1 or L>10	0	
Bubble	SPEC (unit: mm)	Acceptable	
	D≦0.3	Ignored	•
	Non visible area	Ignored	0 L
	0.3 <d≦0.5, distance="">5</d≦0.5,>	n≦5	D= (L + W) / 2
	D>0.5	0	U
Polarizer flaw or leak out resin	Defect is defined as the active area.		
Cover & Sensor Crack	Prohibited	The second secon	
Cover angle	SPEC (unit: mm)	Acceptable	Y T
missing	Side/Bottom		
	It is prohibited if the defect appears on the front.	0	
Cover edge	SPEC (unit: mm)	Acceptable	
break	X≦3.0, Y≦3.0, Z≦T	Ignored	
	X>3.0, Y>3.0, Z>T	0	T
Ink	SPEC (unit: mm)	Acceptable	
	word unclear, inverted, mistake, break line	0	
Bubble under	SPEC (unit: mm)	Acceptable	
protection film	NA		
Function	Prohibited		



13.3 Sampling Condition

Unless otherwise agree in written, the sampling inspection shall be applied to the incoming inspection of customer.

Lot size: Quantity of shipment lot per model.

Sampling type: normal inspection, single sampling

Sampling table: MIL-STD-105E

Inspection level: Level II

	Definition		
Class of defects	Major	AQL 0.65%	It is a defect that is likely to result in failure or to reduce materially the usability of the product for the intended function.
	Minor	AQL 1.5%	It is a defect that will not result in functioning problem with deviation classified.



CTP LCM Product Label style:



Barcode Define:









15. PRECAUTIONS IN USE LCM

1. ASSEMBLY PRECAUTIONS

- Since Touch Panel is consist of glass, please be careful your hands to be injured during handing. You must wear gloves during handing.
- (2) Do not touch, push or rub the exposed touch panel, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment.
- (3) Do not stack the touch panels together.Do not put heavy objects on touch panel.
- (4) Please do not take a CTP to pieces and reconstruct it. Resolving and reconstructing modules may cause them not to work well.
- (5) Please excessive force or strain to the panel or tail is prohibited, Do not lift touch panel by cable(FPC).
- (6) Use clean sacks or glove to prevent fingerprints and/or stains left on the panel. Extra attention and carefulness should be taken while handling the glass edge.
- (7) Please pay attention for the matters stated below at mounting design of touch panel enclosure.

Enclosure support to fix touch panel must be out

of active area.(do not design enclosure presses

the active area to protect from miss put)

2 .OPERATING PRECAUTIONS

- (1) Please be sure to turn off the power supply before connecting and disconnecting signal input cable.
- (2) Please do not change variable resistance settings in CTP. They are adjusted to the most suitable value. If they are changed, it might happen CTP does not satisfy the characteristics specification
- (3) Be careful for condensation at sudden temperature change. Condensation makes damage to snesor or electrical contacted parts.
- (4) CTP has high frequency circuits. Sufficient suppression to the electromagnetic interference shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- (5) Touch the panel with your finger or stylus only to assure normal operation. Any sharp edged or hard objects are prohibited.
- (6) Operate the panel in a steady environment. Abrupt variation on temperature and humidity may cause malfunction of the panel.

3. ELECTROSTATIC DISCHARGE CONTROL

(1) The operator should be grounded whenever he/she comes into contact with the CTP. Never touch any of the conductive parts such the copper leads on the FPC and the interface terminals with any parts of the human body.

Confidential Document

- (2) The CTP should be kept in antistatic bags or other containers resistant to static for storage.
- (3) Only properly grounded soldering irons should be used.
- (4) If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.
- (5) The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended
- (6) Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

4. STORAGE PRECAUTIONS

- (1) When you store touch panel for a long time, it is recommended to keep the temperature between 0°C-40°C without the exposure of sunlight and to keep the humidity less than 90%RH.
- (2) Please do not leave touch panel in the environment of high humidity and high temperature such as 60°C 90%RH
- (3) Please do not leave touch panel in the environment of low temperature; below -20°C.

5. OTHERS

For the packaging box, please pay attention to the

followings:

- (4) Please do not pile them up more than 5 boxes.(They are not designed so.) And please do not turn over.
- (5) Please handle packaging box with care not to give them sudden shock and vibrations. And also please do not throw them up.
- (6) Packing box and inner case for CTP are made of cardboard. So please pay attention not to get them wet. (Such like keeping them in high humidity or wet place can occur getting them wet.)

6. LIMITED WARRANTY

Unless otherwise agreed between DATA IMAGE and customer, DATA IMAGE will replace or repair any of its CTP which is found to be defective electrically and visually when inspected in accordance with DATA IMAGE acceptance standards, for a period on one year from date of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of DATA IMAGE is limited to repair and/or replacement on the terms set forth above. DATA IMAGE will not responsible for any subsequent or consequential events.





16. OUTLINE DRAWING



17. PACKAGE INFORMATION

TBD